、	Connector	:s
S	PECIFICATION	J
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SPEC. NO.: <u>PS-50519-X</u>	XXXX-XXX REV	VISION: <u>A</u>
PRODUCT NAME: 0.8 r	nm PITCH EASY ON FPC	CONN.
<u>SM</u>	R/A B/C TYPE	
PRODUCT NO: 5051	9-XXXX-XXX	
PREPARED:	CHECKED:	APPROVED:
Xufei	Jerry	Jason Chen
DATE: 2014.01.14	DATE: 2014.01.14	DATE: 2014.01.14



TITLE: 0.8 MM PITCH EASY ON FPC CONN. SMT R/A BOTTOM CONTACT TYPE

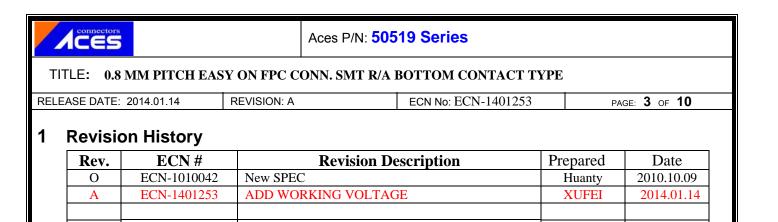
RELEASE DATE: 2014.01.14

REVISION: A

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EASE I	DATE: 2014.01.14	REVISION: A	ECN No: ECN-1401253	PAGE: 2 OF 10
1	REVISION HISTO			
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	Aces P/N: 50519 Series									
T	TITLE: 0.8 MM PITCH EASY ON FPC CONN. SMT R/A BOTTOM CONTACT TYPE									
REL	ELEASE DATE: 2014.01.14 REVISION: A ECN No: ECN-1401253 PAGE: 4 OF 10									
2	2 SCOPE This specification covers performance, tests and quality requirements for 0.8 mm pitch easy on FPC SMT Type connector.									
3	APPLICA		UMENTS							
	EIA-364	ELECTF	RONICS IN	DUSTRIES A	SSOCIATION					
4	REQUIRI	EMENTS								
	4.1 Design	and Construc	ction							
	4.1.1 Product shall be of design, construction and physical dimensions specified on									
	applicable product drawing. 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101. 4.2 Materials and Finish									
	 4.2.1 Contact: High performance copper alloy (Phosphor Bronze) Plated: (a) Finish: Gold flash overall (b) Under plate: Nickel-plated all over 4.2.2 Housing: Thermoplastic, High temp. UL94V-0 									
	4.3 Ratings	;								
	 4.3 Ratings 4.3.1 Working voltage less than 36 volts (per pin) 4.3.2 Voltage: 50 Volts AC (per Pin) 4.3.3 Current: 0.5 Amperes (per Pin) 4.3.4 Operating Temperature : -40°C to +85°C 									



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5 Performance

5.1. Test Requirements and Procedures Summary

REVISION: A

ltem	Requirement	Standard				
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.				
	ELECTRICA	NL				
Low Level Contact Resistance	$\frac{55 \text{ m } \Omega}{20 \text{ m } \Omega}$ Max.(initial)per contact 20 m Ω Max. Change allowed	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)				
Insulation Resistance	500 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)				
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 2 mA max.	AC 250 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)				
Temperature rise	30℃ Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25° (EIA-364-70 METHOD 1, CONDITION1)				
	MECHANIC	• •				
Item	Requirement	Standard				
Durability	30 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3 mm/min. (EIA-364-09)				
FPC Retention Force	4 to 15pin=100g/per pin (min) 16 to 29pin=75g/per pin (min) For 30pin 以上=40g/per pin(min)	Insert the actuator, pull the FPC at the speed rate of 25.4 ± 3 mm/min for 10 cycles.				
Terminal / Housing		Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing.				
Fitting nail / Housing Retention Force	0.1kgf MIN.	Operation Speed: 25.4 ± 3 mm/minute. Measure the contact retention force with Tensile strength tester.				

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Item	Requirement	Standard				
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)				
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be DC 100mA maximum for all contacts. (EIA-364-27, test condition A)				
	ENVIRONMEN	ITAL				
ltem	Requirement	Standard				
Resistance to Reflow Soldering Heat	See Product Qualification and Test Sequence Group 10 (Lead Free)	Pre Heat : 150°C~180°C, 60~120sec. Heat : 230°C Min., 40sec Min. Peak Temp. : 260°C Max, 10sec Max.				
Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles.				
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector				
Temperature life	See Product Qualification and Test Sequence Group 5	Subject mated connectors to				
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to				



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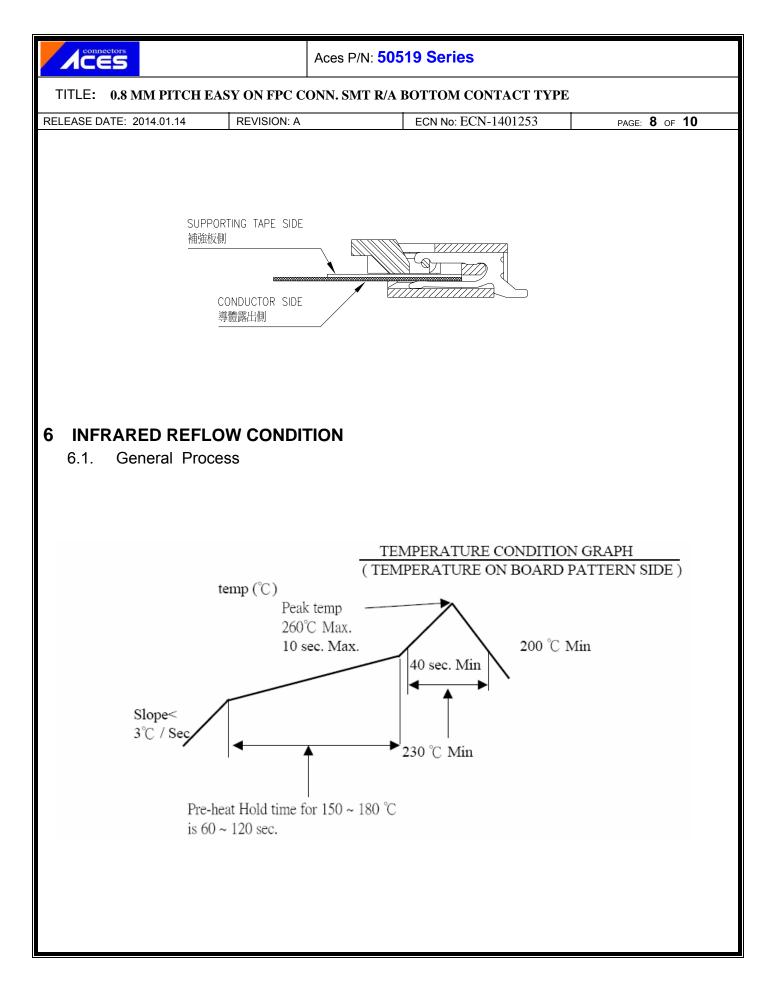
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ltem	Requirement	Standard			
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage.	And then into solder bath, Temperature at 245 ±5℃, for 4-5 sec. (EIA-364-52)			
Hand Soldering Temperature Resistance	Appearance : No damage	$T\!\geq\!350^\circ\!\mathrm{C}$, 3 sec at least			

Note 1. Flowing Mixed Gas shell be conduct by customer request.



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7 PRODUCT QUALIFICATION AND TEST SEQUENCE

		Test Group									
Test or Examination	1	2	3	4	5	6	7	8	9	10	11
					Test	Seque	ence				
Examination of Product				1 • 7	1、6	1、4				1	1
Low Level Contact Resistance		1、5	1、4	2 \ 10	2 \ 9	2 \ 5				3	
Insulation Resistance				3、9	3、8						
Dielectric Withstanding Voltage				4 • 8	4 \ 7						
Temperature rise	1										
Durability		3									
Vibration			2								
Shock (Mechanical)			3								
Thermal Shock				5							
Humidity				6							
Temperature life					5						
Salt Spray (Only For Gold Plating)						3					
Solder ability							1				
FPC Retention Force								1			
Terminal /Housing Retention Force									1		
Fitting Nail / Housing Retention Force									2		
Resistance to Soldering Heat										2	
Hand Soldering Temperature Resistance											2
Sample Size	2	4	4	4	4	4	2	4	4	4	4

